

Electronic Patent Application Fee Transmittal

Application Number:	10594221			
Filing Date:	25-Sep-2006			
Title of Invention:	Silicon-containing curing composition and heat cured product thereof			
First Named Inventor/Applicant Name:	Takashi Sueyoshi			
Filer:	Eric Jensen/Linda Sayyad			
Attorney Docket Number:	8007-1116			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Request for continued examination	1801	1	810	810
Processing Fee, except for Provis. apps	1808	1	130	130
Total in USD (\$)				940